

Date:

08-Jul-2022

**Product Category:** 

# **Product Change Notification / ALAN-15MUYV374**

Clock and Timing - Clock and Data Distribution

PCN Type:
Manufacturing Change
Notification Subject:
CCB 4575.002 Final Notice: Qualification of MTAI as a new assembly site for selected SY898xx and SY100EP111UTG device families available in 32L TQFP (7x7x1mm) package.
Affected CPNs:
ALAN-15MUYV374_Affected_CPN_07082022.pdf ALAN-15MUYV374_Affected_CPN_07082022.csv
Notification Text:
PCN Status:
Final Notification
PCN Type:Manufacturing Change
<b>Microchip Parts Affected:</b> Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)
<b>Description of Change:</b> Qualification of MTAI as a new assembly site for selected SY898xx and SY100EP111UTG device families available in 32L TQFP (7x7x1mm) package.
Pre and Post Change Summary:
· ·

		Pre Change	Post Change					
Assembly Site		Amkor Technology Philippine (P1/P2), INC. (ANAP)	Microchip Technology Thailand (HQ) (MTAI)					
Wire	e Material	Au	Au					
Die Att	ach Material	3230	QMI519					
Molding Co	mpound Material	d Material G700						
Moisture Sensitivity Level (MSL)		MSL 2	MSL 1					
	Material	C194	C7025					
	Paddle Size	138x138	197x197					
Lead-Frame	DAP Surface Prep	Double Ring	Ag selective					
	Lead-lock	Yes	No					
		See pre and post change con	nparison					
	Color	Black	Blue					
Tray	Туре	Bakeable	Non-bakeable					
	See pre and post change comparison							

### Impacts to Data Sheet:None

Change ImpactNone

**Reason for Change:**To improve manufacturability by qualifying a new assembly site.

**Change Implementation Status:**In Progress

Estimated First Ship Date:June 30, 2022 (date code: 2227)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

## Time Table Summary:

	May 2022				June 2022				
Workweek	1	2	2	2	2	2	2	2	2
T STATE OF A	9	0	1	2	3	4	5	6	7
Qual Report Availability				Χ					

	Final PCN Issue Date		Х			
I	Estimated Implementation					V
-	Date					^

Method to Identify Change: Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:**May 24, 2022: Issued final notification.

May 26, 2022: Re-issued final notification to correct Package from TQPF to TQFP.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

#### **Attachments:**

PCN\_ALAN-15MUYV374\_Pre and Post Change\_Summary.pdf PCN\_ALAN-15MUYV374\_Qualification\_Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

ALAN-15MUYV374 - CCB 4575.002 Final Notice: Qualification of MTAI as a new assembly site for selected SY898xx and SY100EP111UTG device families available in 32L TQFP (7x7x1mm) package.

Affected Catalog Part Numbers (CPN)

SY89809ALTZ

SY898531LTZ

SY89809ALTZ-TR

SY898531LTZ-TR

SY100EP111UTG

SY100EP111UTG-TR

SY100EP111UTG-TX

Date: Thursday, July 07, 2022